

Please cancel dependent claim 53 and combine into claim 5:

5. (Currently Amended) A cooling apparatus adapted for cooling a heat-generating substrate by cold vapor refrigeration, comprising a refrigeration loop including:

a refrigerant compressor (32),

a condenser (44) for receiving refrigerant from said compressor and for outputting heat to ambient air, thereby cooling said refrigerant,

a fan (20) arranged to pass said ambient air past said condenser (44),

a throttle valve (62) for receiving cooled refrigerant from said condenser (44), and adapted to permit isenthalpic expansion of the refrigerant,

an evaporator (60; 100) having a primary heat-transfer surface (104) formed of a highly heat-conductive material, adapted to receive refrigerant from said throttle valve (62), and thermally coupled to the heat-generating substrate (12),

a common drive motor (42) adapted to drive both said compressor (32) and said fan (20), and

a controller (54) adapted to receive a signal corresponding to refrigerant temperature, and to control said temperature by controlling a rotation speed of said fan (20).

Please rewrite claim 34 in independent form:

34. (Previously Presented) ~~The cooling apparatus of claim 5,~~  
A cooling apparatus adapted for cooling  
a heat-generating substrate by cold vapor refrigeration,  
comprising a refrigeration loop including:  
a refrigerant compressor (32),  
a condenser (44) for receiving refrigerant from said compressor and for  
outputting heat to ambient air, thereby cooling said refrigerant,  
a fan (20) arranged to pass said ambient air past said condenser (44),  
a throttle valve (62) for receiving cooled refrigerant from said  
condenser (44), and adapted to permit isenthalpic expansion of the  
refrigerant,  
an evaporator (60; 100), adapted to receive refrigerant from said  
throttle valve (62), and thermally coupled to the heat-generating substrate  
(12),  
a common drive motor (42) adapted to drive both said compressor (32) and  
said fan (20), and  
a controller (54) adapted to receive a signal  
corresponding to refrigerant temperature, and to control said temperature by  
controlling a rotation speed of said fan (20);  
wherein said compressor (32) and said fan (20)  
constitute a pair of driven units, and  
said motor (42) drives one of said driven units directly and  
drives the other of said driven units via a magnetic coupling.

35. (Currently Amended) The cooling apparatus of claim ~~5~~ 34, wherein  
said drive motor (42), said fan (20) and said compressor (32)  
are commonly housed in a single module.

36. (Currently Amended) The cooling apparatus of claim ~~5~~ 34, wherein  
said refrigeration loop is a counterclockwise circular process.

Please rewrite claim 37 in independent form:

37. (Currently Amended) The cooling apparatus of claim 5,  
A cooling apparatus adapted for cooling  
a heat-generating substrate by cold vapor refrigeration,  
comprising a refrigeration loop including:  
a refrigerant compressor (32),  
a condenser (44) for receiving refrigerant from said compressor and for  
outputting heat to ambient air, thereby cooling said refrigerant,  
a fan (20) arranged to pass said ambient air past said condenser (44),  
a throttle valve (62) for receiving cooled refrigerant from said  
condenser (44), and adapted to permit isenthalpic expansion of the  
refrigerant,  
an evaporator (60; 100), adapted to receive refrigerant from said  
throttle valve (62), and thermally coupled to the heat-generating substrate  
(12),  
a common drive motor (42) adapted to drive both said compressor (32) and  
said fan (20), and  
a controller (54) adapted to receive a signal  
corresponding to refrigerant temperature, and to control said temperature by  
controlling a rotation speed of said fan (20);  
wherein said apparatus stages are dimensioned such that, and  
said controller is configured such that, at least some of  
said refrigerant undergoes phase changes between a vapor phase and a liquid  
phase.

38. (Previously Presented) The cooling apparatus of claim 37, wherein,  
during operation, refrigerant, in said evaporator (60; 60') stage,  
is present as a boiling liquid (52a) and as a saturated vapor (52d).

Please rewrite claim 39 in independent form and add features of claims 40-41:

39. (Previously Presented) ~~The cooling apparatus of claim 5,~~  
A cooling apparatus adapted for cooling  
a heat-generating substrate by cold vapor refrigeration,  
comprising a refrigeration loop including:  
a refrigerant compressor (32),  
a condenser (44) for receiving refrigerant from said compressor and for  
outputting heat to ambient air, thereby cooling said refrigerant,  
a fan (20) arranged to pass said ambient air past said condenser (44),  
a throttle valve (62) for receiving cooled refrigerant from said  
condenser (44), and adapted to permit isenthalpic expansion of the  
refrigerant,  
an evaporator (60; 100), adapted to receive refrigerant from said  
throttle valve (62), and thermally coupled to the heat-generating substrate  
(12),  
a common drive motor (42) adapted to drive both said compressor (32) and  
said fan (20), and  
a controller (54) adapted to receive a signal  
corresponding to refrigerant temperature, and to control said temperature  
by controlling a rotation speed of said fan (20);  
wherein said fan and said compressor are mounted  
in a common housing (40) molded of plastic material.

40. (Cancelled) The cooling apparatus of claim 39, wherein  
said common housing (40) is a molded element.

41. (Cancelled) The cooling apparatus of claim 40, wherein  
said molded element comprises a plastic material.

Please rewrite claim 42 in independent form:

42. (Currently Amended) ~~The cooling apparatus of claim 5,~~  
A cooling apparatus adapted for cooling  
a heat-generating substrate by cold vapor refrigeration,  
comprising a refrigeration loop including:  
a refrigerant compressor (32),  
a condenser (44) for receiving refrigerant from said compressor and for  
outputting heat to ambient air, thereby cooling said refrigerant,  
a fan (20) arranged to pass said ambient air past said condenser (44),  
a throttle valve (62) for receiving cooled refrigerant from said  
condenser (44), and adapted to permit isenthalpic expansion of the  
refrigerant,  
an evaporator (60; 100), adapted to receive refrigerant from said  
throttle valve (62), and thermally coupled to the heat-generating substrate  
(12),  
a common drive motor (42) adapted to drive both said compressor (32) and  
said fan (20), and  
a controller (54) adapted to receive a signal  
corresponding to refrigerant temperature, and to control said temperature by  
controlling a rotation speed of said fan (20);  
wherein said evaporator (60; 100) is configured as an impact plate.

43. (Previously Presented) The cooling apparatus of claim 42,  
wherein a nozzle (114) is formed at an entry point for refrigerant (52)  
entering said evaporator (100).

44. (Previously Presented) The cooling apparatus of claim 43,  
wherein said nozzle is configured as an orifice nozzle.

45. (Previously Presented) The cooling apparatus of claim 43, wherein  
said nozzle is configured as a slit nozzle.

46. (Previously Presented) The cooling apparatus of claim 43, wherein  
said nozzle is configured as a vena contracta to behave according to the  
Coanda effect.

Please rewrite claim 47 in independent form:

47. (Currently Amended) ~~The cooling apparatus of claim 5,~~  
A cooling apparatus adapted for cooling  
a heat-generating substrate by cold vapor refrigeration,  
comprising a refrigeration loop including:  
a refrigerant compressor (32),  
a condenser (44) for receiving refrigerant from said compressor and for  
outputting heat to ambient air, thereby cooling said refrigerant,  
a fan (20) arranged to pass said ambient air past said condenser (44),  
a throttle valve (62) for receiving cooled refrigerant from said  
condenser (44), and adapted to permit isenthalpic expansion of the  
refrigerant,  
an evaporator (60; 100), adapted to receive refrigerant from said  
throttle valve (62), and thermally coupled to the heat-generating substrate  
(12),  
a common drive motor (42) adapted to drive both said compressor (32) and  
said fan (20), and  
a controller (54) adapted to receive a signal  
corresponding to refrigerant temperature, and to control said temperature by  
controlling a rotation speed of said fan (20);  
wherein said evaporator (100) has a substrate-adjacent surface and a  
substrate-remote surface, and said substrate-remote surface defines a concave  
surface (114) for contact with said refrigerant.

48. (Previously Presented) The cooling apparatus of claim 47, wherein  
said concave surface is shaped substantially as a spherical shell.

49. (Previously Presented) The cooling apparatus of claim 47, wherein  
said concave surface is shaped as a rotation surface of a paraboloid.

50. (Previously Presented) The cooling apparatus of claim 47, wherein  
a plurality of mutually-spaced heat-transfer elements (116) are formed on said  
concave surface (114).

51. (Previously Presented) The cooling apparatus of claim 50, wherein  
said heat-transfer elements (116) are, at least partially, needle-shaped.

52. (Previously Presented) The cooling apparatus of claim 43, wherein,  
adjacent an entry point (114) for refrigerant entering said evaporator (100),  
at least one obstruction (124) is provided, to impede direct flow of  
refrigerant from an inlet (112) of said evaporator to an outlet (126) thereof.

53. (Cancelled) The cooling apparatus of claim 5, wherein a primary heat-transfer surface (104) of said evaporator is formed of a highly heat-conductive material.

Please rewrite claim 54 in independent form:

54. (Previously Presented) ~~The cooling apparatus of claim 5,~~  
A cooling apparatus adapted for cooling  
a heat-generating substrate by cold vapor refrigeration,  
comprising a refrigeration loop including:

a refrigerant compressor (32),  
a condenser (44) for receiving refrigerant from said compressor and for  
outputting heat to ambient air, thereby cooling said refrigerant,  
a fan (20) arranged to pass said ambient air past said condenser (44),  
a throttle valve (62) for receiving cooled refrigerant from said  
condenser (44), and adapted to permit isenthalpic expansion of the  
refrigerant,

an evaporator (60; 100), adapted to receive refrigerant from said  
throttle valve (62), and thermally coupled to the heat-generating substrate  
(12),

a common drive motor (42) adapted to drive both said compressor (32) and  
said fan (20), and

a controller (54) adapted to receive a signal  
corresponding to refrigerant temperature, and to control said temperature by  
controlling a rotation speed of said fan (20);

wherein said evaporator is made of a highly heat-conductive material ~~is~~  
namely a metal selected from the group consisting of aluminum,  
aluminum alloys, copper, copper alloys, silver and silver alloys.

55. (Currently Amended) The cooling apparatus of claim ~~5~~ 34, wherein said evaporator (100) comprises an assembly formed with a refrigerant inlet (112) and a refrigerant outlet (126).

Please rewrite claim 56 in independent form:

56. (Currently Amended) ~~The cooling apparatus of claim 5,~~  
A cooling apparatus adapted for cooling  
a heat-generating substrate by cold vapor refrigeration,  
comprising a refrigeration loop including:  
a refrigerant compressor (32),  
a condenser (44) for receiving refrigerant from said compressor and for  
outputting heat to ambient air, thereby cooling said refrigerant,  
a fan (20) arranged to pass said ambient air past said condenser (44),  
a throttle valve (62) for receiving cooled refrigerant from said  
condenser (44), and adapted to permit isenthalpic expansion of the  
refrigerant,  
an evaporator (60; 100), adapted to receive refrigerant from said  
throttle valve (62), and thermally coupled to the heat-generating substrate  
(12),  
a common drive motor (42) adapted to drive both said compressor (32) and  
said fan (20), and  
a controller (54) adapted to receive a signal  
corresponding to refrigerant temperature, and to control said temperature by  
controlling a rotation speed of said fan (20);  
wherein said evaporator (100) comprises a plurality of parts (102, 104)  
coupled fluid-tightly together.

57. (Previously Presented) The cooling apparatus of claim 56, further  
comprising a radial seal (134) fluid-tightly coupling said parts to each  
other.

58. (Previously Presented) The cooling apparatus of claim 56, further  
comprising a mounting flange (140) integrally formed with one of said  
evaporator parts.



59. (Currently Amended) A method of cooling a surface of a heat-generating electronic device, using a refrigeration loop, comprising the steps of:

- compressing a refrigerant in a compressor (32);
- feeding said refrigerant from said compressor (32) through a condenser (44) being ~~cooling~~ cooled by a fan (20);
- subjecting said refrigerant from said condenser (44) to an expansion step to reduce its pressure and its temperature, until it is present as a boiling liquid and a wet vapor;
- applying said boiling liquid and wet vapor to a heat-transfer surface (114) in an evaporator (100) thermally coupled to said heat-generating electronic device; and
- returning refrigerant from said evaporator to said compressor (32);

wherein said compressor (32) and said fan (20) rotate according to drive energy from a common motor (42), and wherein a temperature of said refrigerant is monitored and controlled (54) by controlling rotation speed of said common motor (42).

60. (Previously Presented) The method of claim 59, wherein said step of subjecting said refrigerant to expansion comprises isenthalpically expanding said refrigerant.

61. (Previously Presented) The method of claim 59 wherein said step of compressing said refrigerant comprises heating said refrigerant to a temperature ( $t_2$ ) higher than a temperature of a medium to be used for cooling said refrigerant.

62. (Previously Presented) The method of claim 61, further comprising using ambient air to cool said refrigerant, and said step of heating said refrigerant comprises heating said refrigerant to a temperature ( $t_2$ ) warmer than a temperature ( $t_a$ ) of said ambient air.